# **MPQ3323B**



4-Channel, 320mA/Ch, LED Driver with Separated PWM/Analog Dimming and I<sup>2</sup>C Interface, AEC-Q100 Qualified

# DESCRIPTION

The MPQ3323B is a 4-channel LED driver that can operate from a wide 4.5V to 16V input voltage (V<sub>IN</sub>) range. The MPQ3323B applies four internal current sources in each LED string terminal. The LED current (I<sub>LED</sub>) of each channel is set by an external current-setting resistor. The maximum current for each channel is 320mA.

The MPQ3323B integrates an I<sup>2</sup>C interface with up to 10 configurable I<sup>2</sup>C addresses via an external resistor. This means the MPQ3323B can support up to 10 ICs cascaded ICs to drive the LED array. Each channel can be enabled or disabled via the I<sup>2</sup>C.

The MPQ3323B employs both separated pulsewidth modulation (PWM) dimming and analog dimming for each LED channel, as well as 12-bit PWM dimming and 6-bit analog dimming for each channel. The  $I_{\text{LED}}$  ramping rate and phase shift can be configured to reduce EMI.

The MPQ3323B can output a refresh signal from the RFSH/FLT pin. The refresh signal frequency (f<sub>REFRESH</sub>) can be set via the I<sup>2</sup>C.

Full protections features include LED open protection, LED short protection, and over-temperature protection (OTP). The device also features a fault indicator. If a protection is triggered, then the RFSH/FLT pin is pulled low, and the corresponding fault register is set.

The MPQ3323B is AEC-Q100 qualified, and is available in a QFN-24 (4mmx4mm) package.

#### **FEATURES**

- Wide 4.5V to 16V Input Voltage (V<sub>IN</sub>) Range
- 4 Channels, Max 320mA/Ch
- LED Current (I<sub>LED</sub>) Configured via External Resistor
- 6-Bit Analog Dimming for Each Channel
- 12-Bit Pulse-Width Modulation (PWM)
   Dimming for Each Channel
- Selectable 220Hz, 250Hz, 280Hz, or 330Hz
   PWM Dimming Frequency (f<sub>PWM</sub>)
- Refresh Signal Output
- I<sup>2</sup>C Interface
- 10 Addresses Configurable via External Resistor
- Configurable I<sub>LED</sub> Slew Rate
- Fault Indicator
- LED Open Protection
- LED Short Protection with Configurable Threshold
- Under-Voltage Lockout (UVLO) Protection
- Over-Temperature Protection (OTP)
- Available in a QFN-24 (4mmx4mm) Package
- Available in a Wettable Flank Package
- Available in AEC-Q100 Grade 1

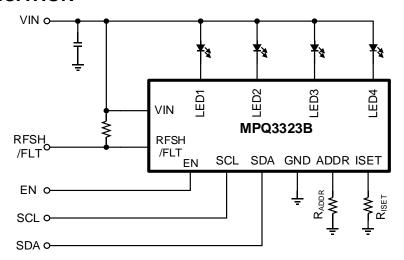
# **APPLICATIONS**

- Automotive Displays
- Instruments Clusters
- General Industrial Displays

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# TYPICAL APPLICATION



**Figure 1: Typical Application** 

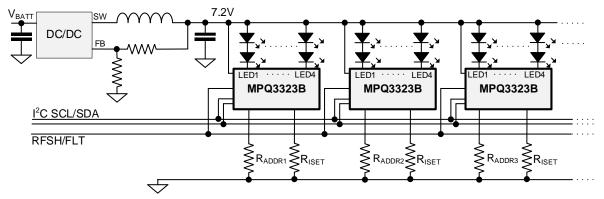


Figure 2: System Application Circuit with 2 LEDs in Series

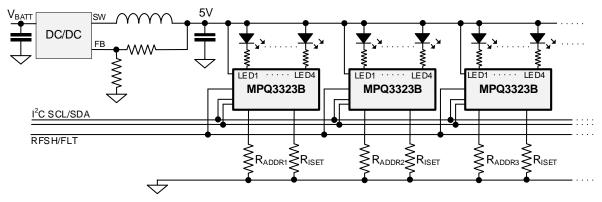


Figure 3: System Application Circuit with 1 LED and Resistor in Series



# ORDERING INFORMATION

Part Number*	Package	Top Marking	MSL Level**
MPQ3323BGRE-AEC1***	QFN-24 (4mmx4mm)	See Below	1

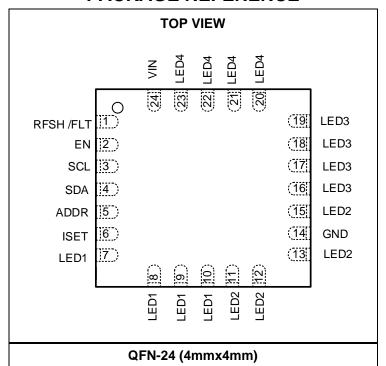
\* For Tape & Reel, add suffix -Z (e.g. MPQ3323BGRE-AEC1-Z). \*\* Moisture Sensitivity Level Rating \*\*\* Wettable flank

# **TOP MARKING**

**MPSYWW** M3323B LLLLLL E

MPS: MPS prefix Y: Year code WW: Week code M3323B: Part number LLLLL: Lot number E: Wettable Flank

# **PACKAGE REFERENCE**



3



# PIN FUNCTIONS

Pin#	Name	Description	
1	RFSH/FLT	<b>Refresh signal output or fault flag.</b> If the FLTEN bit = 0, then the RFSH/FLT pin outputs a synchronized signal that is set by the FRFSH[9:0] register. If FLTEN = 1, RFSH/FLT is used to indicate fault conditions and is pulled low if a fault occurs.	
2	EN	<b>Enable control.</b> Pull the EN pin high to turn the LED driver on; pull EN low to turn it off.	
3	SCL	I <sup>2</sup> C interface clock input.	
4	SDA	I <sup>2</sup> C interface data input.	
5	ADDR	$I^2C$ address setting. Configure the $I^2C$ addresses by attaching different resistors between the ADDR and GND pins. ADDR sets the 4 least significant bits (LSB) of the $I^2C$ address. There are 10 configurable addresses.	
6	ISET	<b>LED current setting.</b> Connect a current-setting resistor between the ISET and GND pins to configure the current in each LED string.	
7, 8, 9, 10	LED1	<b>LED channel 1 current input.</b> Connect the LED channel 1 cathode to this pin. There are four LED1 pins per channel. Connect these four pins together.	
11, 12, 13, 15	LED2	<b>LED channel 2 current input.</b> Connect the LED channel 2 cathode to this pin. Ther are four LED2 pins per channel. Connect these four pins together.	
14	GND	Ground.	
16, 17, 18, 19	LED3	<b>LED channel 3 current input.</b> Connect the LED channel 3 cathode to this pin. There are four LED3 pins per channel. Connect these four pins together.	
20, 21, 22, 23	LED4	<b>LED channel 4 current input.</b> Connect the LED channel 4 cathode to this pin. There are four LED4 pins per channel. Connect these four pins together.	
24	VIN	<b>Power supply input.</b> The VIN pin supplies power to the IC. Connect a capacitor between the VIN and GND pins.	

# **ABSOLUTE MAXIMUM RATINGS (1)**

V <sub>IN</sub>	0.3V to +22V
$V_{\text{LED1}}$ to $V_{\text{LED4}}$	0.5V to +22V
All other pins	0.3V to +5V
Junction temperature	150°C
Lead temperature	260°C
Storage temperature	65°C to +150°C
Continuous power dissipation	
QFN-24 (4mmx4mm)	2.97W

# ESD Ratings

Human body model (HE	3M)	Class 1C (3)
Charged device model (	(CDM)	. Class C2b (4)

# **Recommended Operating Conditions**

Input voltage (V <sub>IN</sub> )	4.5V to 16V
Operating junction temp (T <sub>J</sub> ) <sup>(5)</sup> .	

# Thermal Resistance θ<sub>JA</sub> θ<sub>JC</sub> QFN-24 (4mmx4mm) 42 ...... 9.... °C/W

#### Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature  $T_J$  (MAX), the junction-to-ambient thermal resistance  $\theta_{JA}$ , and the ambient temperature  $T_A$ . The maximum allowable continuous power dissipation at any ambient temperature is calculated by  $P_D$  (MAX) =  $(T_J(\text{MAX}) T_A) / \theta_{JA}$ . Exceeding the maximum allowable power dissipation can generate an excessive die temperature, which may cause the device to go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- Per AEC-Q100-002.
- Per AEC-Q100-011.
- Operating devices at a junction temperature up to 150°C is possible. Please contact an MPS FAE for details.
- 6) Measured on a JESD51-7, 4-layer PCB. The values given in this table are only valid for comparison with other packages and cannot be used for design purposes. These values are calculated in accordance with JESD51-7, and simulated on a specified JEDEC board. They do not represent the performance obtained in an actual application. The θ<sub>JC</sub> value shows the thermal resistance from the junction to case bottom.



# **ELECTRICAL CHARACTERISTICS**

 $V_{IN}$  = 5V,  $V_{EN}$  = 5V,  $T_J$  = -40°C to +125°C, typical values are tested at  $T_J$  = 25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
	Зуший	Condition	IVIIII	ıур	IVIAX	UIIIIS
nput Supply Voltage  nput voltage V <sub>IN</sub> 4.5 16 V						V
Ouisseent supply surrent	_		4.5			mA
Quiescent supply current Shutdown supply current	IQ I <sub>SD</sub>	$V_{EN} = 0V, V_{IN} = 16V$			5	μA
V <sub>IN</sub> under-voltage lockout	ISD	VEN = 0V, VIN = 10V				μΑ
(UVLO) rising threshold	VIN_UVLO_RISING	Rising edge	3.5	3.7	3.9	V
V <sub>IN</sub> UVLO falling threshold	V <sub>IN_UVLO_FALLING</sub>	Falling edge	3.2	3.4	3.6	V
Enable (EN)	·					
EN rising threshold	V <sub>EN_RISING</sub>	V <sub>EN</sub> rising	2.1			V
EN falling threshold	V <sub>EN_</sub> FALLING	V <sub>EN</sub> falling			0.8	V
EN pull-down resistance	R <sub>EN</sub>			1		ΜΩ
RFSH/FLT						
Refresh signal frequency	frefresh	FRFSH[9:0] = 0x1A9, FPWM[1:0] = 01	285	300	315	Hz
RFSH/FLT pull-down resistance	R <sub>RFSH/FLT</sub>	FLTEN = 1, a fault has occurred			100	Ω
LED Regulator						
ISET voltage	V <sub>ISET</sub>	$T_A = 25$ °C	1.176	1.2	1.224	V
		$R_{ISET} = 24k\Omega$ , $ICHx[5:0] = 0x3F$	-5%	200	+5%	mA
LED current 1	I <sub>LED1</sub>	$R_{ISET} = 24k\Omega$ , $ICHx[5:0] = 0x3F$ , $T_A = 25^{\circ}C$	-3%	200	+3%	mA
		$R_{ISET} = 15k\Omega$ , $ICHx[5:0] = 0x3F$	-5%	320	+5%	mA
LED current 2	I <sub>LED2</sub>	R <sub>ISET</sub> = $15k\Omega$ , ICHx[5:0] = 0x3F, T <sub>A</sub> = $25^{\circ}$ C	-3%	320	+3%	mA
Current sink handroom	V	I <sub>LED</sub> = 200mA		200	300	mV
Current sink headroom	$V_{LEDX}$	I <sub>LED</sub> = 320mA		380	480	mV
Dimming						•
Pulse-width modulation (PWM) frequency	f <sub>РWМ</sub>	FPWM[1:0] = 01	240	250	260	Hz
PWM duty step	tрwм	12-bit resolution, f <sub>PWM</sub> = 250Hz		1		μs
Phase shift	tDELAY	PS_EN = 1		160		μs
LED current step		I <sub>LED</sub> = 320mA, analog dimming step		5		mA
LED current slew rate		SLEW[1:0] = 01, rising edge		5		μs
during PWM dimming		SLEW[1:0] = 11, rising edge		20		μs
Protections						
LED short string protection threshold	V <sub>SLP</sub>	STH[1:0] = 01	2.85	3	3.15	V
LED short string protection time	t <sub>SLP</sub>	V <sub>LEDx</sub> > STH[1:0]		4		ms
LED short string protection hiccup time	t <sub>SLP_</sub> HICCUP			1		ms



# **ELECTRICAL CHARACTERISTICS** (continued)

 $V_{IN}$  = 5V,  $V_{EN}$  = 5V,  $T_J$  = -40°C to +125°C, typical values are tested at  $T_J$  = 25°C, unless otherwise noted.

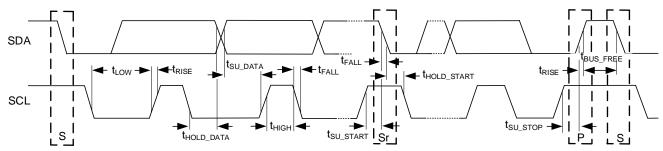
Parameter	Symbol	Condition	Min	Тур	Max	Units
LED short string protection hiccup detection time	tslp_det			32		μs
LED open string protection threshold	Volp			100	150	mV
LED open string protection time	tolp	V <sub>LEDx</sub> < 100mV		4		ms
LED open string protection hiccup time	tolp_HICCUP			1		ms
LED open string protection hiccup detection time	tolp_det			32		μs
Thermal shutdown threshold (7)	T <sub>SD</sub>			170		°C
Thermal shutdown hysteresis (7)	T <sub>SD_HYS</sub>			20		°C
I <sup>2</sup> C Interface						
Logic-low input voltage	$V_{\text{IN\_LOW}}$		0		0.8	V
Logic-high input voltage	V <sub>IN_HIGH</sub>		1.5			V
Logic-low output voltage (7)	Vout_Low	I <sub>LOAD</sub> = 3mA			0.4	V
SCL clock frequency (7)	fscL		10		1000	kHz
Bus free time (7)	t <sub>BUF_FREE</sub>	Between stop and start conditions	0.5			μs
Holding time after start/ repeated start condition (7)	thold_start	After this period, the first clock is generated	0.26			μs
Repeated start condition set-up time <sup>(7)</sup>	tsu_start		0.26			μs
Stop condition set-up time (7)	t <sub>SU_STOP</sub>		0.26			μs
Data hold time (7)	thold_data		0			ns
Data set-up time (7)	tsu_data		50			ns
Clock low timeout (7)	tтімеоит		25		35	ms
Clock low time (7)	t <sub>LOW</sub>		0.5			μs
Clock high time (7)	t <sub>HIGH</sub>		0.26			μs
Clock/data fall time (7)	t <sub>FALL</sub>				120	ns
Clock/data rise time (7)	t <sub>RISE</sub>				120	ns

#### Note:

7) Guaranteed by characterization. Not tested in production.



# I<sup>2</sup>C INTERFACE TIMING DIAGRAM



S = Start Condition

Sr = Repeated Start Condition

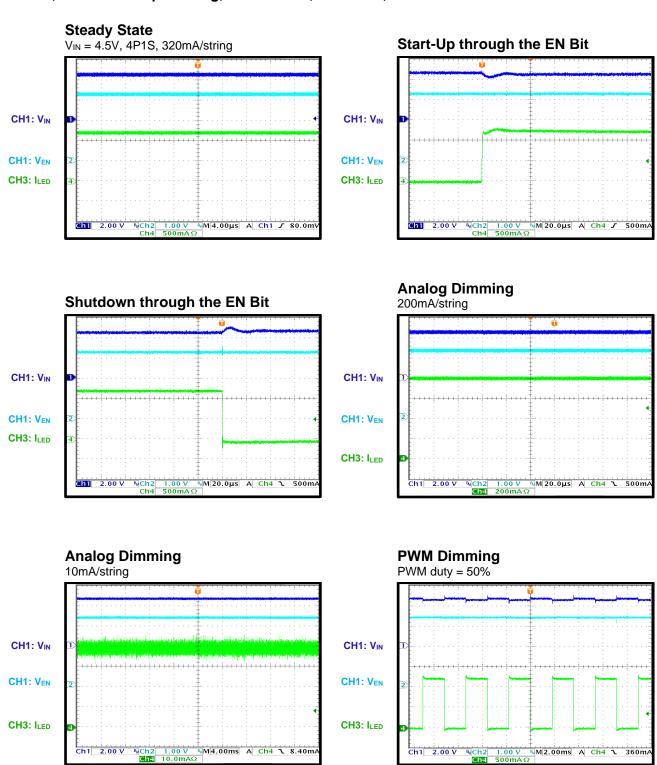
P = Stop Condition

Figure 4: I<sup>2</sup>C Interface Timing Diagram



# TYPICAL PERFORMANCE CHARACTERISTICS

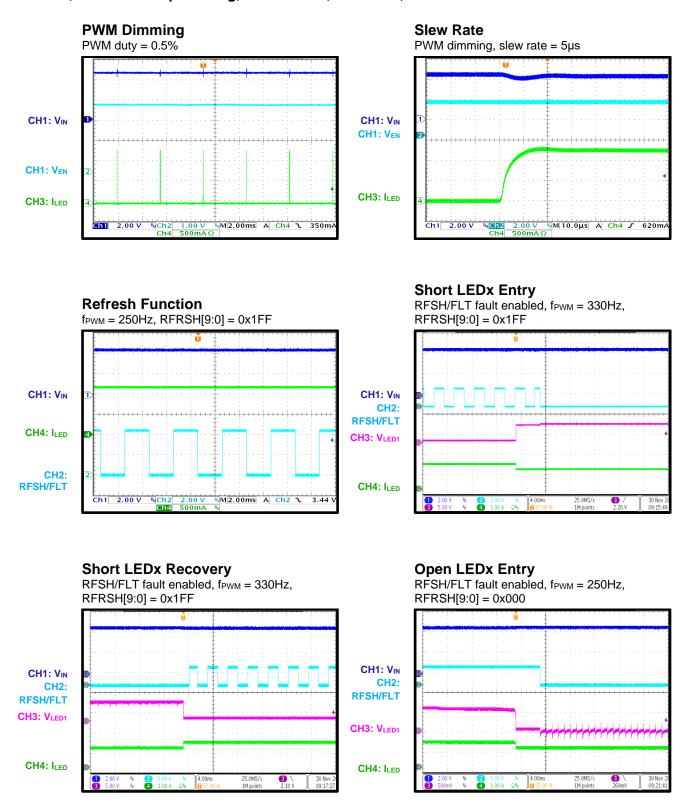
 $V_{IN} = 4.5V$ ,  $I_{LED} = 320$ mA per string, LED = 4P1S,  $T_A = 25$ °C, unless otherwise noted.





# TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 $V_{IN} = 4.5V$ ,  $I_{LED} = 320$ mA per string, LED = 4P1S,  $T_A = 25$ °C, unless otherwise noted.



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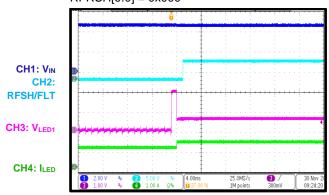


# TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 $V_{IN} = 4.5V$ ,  $I_{LED} = 320$ mA per string, LED = 4P1S,  $T_A = 25$ °C, unless otherwise noted.

# **Open LEDx Recovery**

RFSH/FLT fault enabled, f<sub>PWM</sub> = 250Hz, RFRSH[9:0] = 0x000





# **FUNCTIONAL BLOCK DIAGRAM**

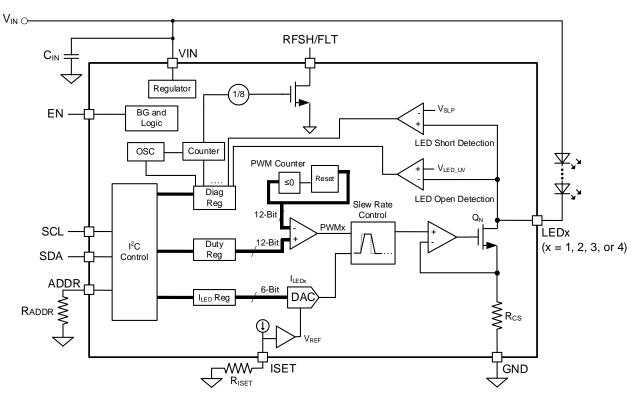


Figure 5: Functional Block Diagram



#### **OPERATION**

The MPQ3323B applies 4 internal current sources in each LED string terminal. The LED current (I<sub>LED</sub>) of all channels is set via an external current-setting resistor, with a maximum current up to 320mA.

#### **Enable (EN) and Start-Up**

Once the input voltage  $(V_{IN})$  exceeds its undervoltage lockout (UVLO) rising threshold  $(V_{IN\_UVLO\_RISING})$  and the EN pin's voltage  $(V_{EN})$  exceeds its rising threshold  $(V_{EN\_RISING})$ , the system starts up.

# **Channel Selection**

The channels can be disabled by pulling the corresponding CHxEN bit (where x = 1, 2, 3, or 4) low.

# **Dimming**

Each channel includes a separate 6-bit analog dimming register and 12-bit pulse-width modulation (PWM) dimming register. The MPQ3323B can support analog dimming and PWM dimming for each channel.

In analog dimming, the  $I_{LED}$  amplitude changes when the analog dimming register changes. Change the code in ICHx (x = 1, 2, 3, or 4) to apply analog dimming for the corresponding channel.  $I_{LED}$  can be estimated with Equation (1):

$$I_{LED} = \frac{ICHx}{63} \times I_{SET}$$
 (1)

Where ICHx is the analog dimming for channel x (where x = 1, 2, 3, or 4). If ICHx is set to 0, then the corresponding  $I_{\text{LED}}$  is 0A.

In PWM dimming,  $I_{LED}$  is a PWM waveform, the  $I_{LED}$  amplitude remains the same, and the  $I_{LED}$  duty varies with the PWM dimming register.

The PWM dimming duty ( $D_{PWM}$ ) is set by the PWMx (x = 1, 2, 3, or 4) register.  $D_{PWM}$  can be calculated with Equation (2):

$$D_{PWM} = \frac{PWMx}{4095} \tag{2}$$

Where PWMx is the  $D_{PWM}$  code for channel x (where x = 1, 2, 3, or 4).

The duty changes only when the PWM duty register's 8 most significant bits (MSB) are written. If PWMx is set to 0, then the corresponding  $I_{\text{LED}}$  is 0A.

The PWM dimming frequency (f<sub>PWM</sub>) can be selected via register FPWM[1:0]. Table 1 shows the FPWM[1:0] register settings for the different PWM frequencies.

**Table 1: PWM Frequency Setting** 

FPWM[1:0]	fрwм
00	220Hz
01	250Hz (default)
10	280Hz
11	330Hz

To avoid glitches during normal operation, follow the steps below:

- 1. Change the FPWM[1:0] value only when the EN bit is set 0.
- Write the FPWM register, then resume writing to the other registers after a 10μs delay.

#### **Phase Shift**

The channel-by-channel phase shift function is enabled by setting the PS\_EN bit high.

When the phase shift is enabled, the rising edge of each channel occurs  $160\mu s$  after the previous channel. This means that the rising edge of the channel x + 1 (where x = 1, 2, or 3)  $I_{LED}$  occurs after the rising edge of channel x's  $I_{LED}$ .

# Synchronized Output for the LCD Refresh Frequency

The fault indication function can be enabled by the FLTEN bit.

If FLTEN = 0, the fault indication function is disabled and the RFSH/FLT pin maintains the output refresh signal, even when a protection is triggered.

If FLTEN = 1, the fault indication function is enabled and RFSH/FLT is pulled low when a fault occurs.



Table 2 shows RFSH/FLT's output status.

Table 2: RFSH/FL1	<sup>·</sup> Pin	Output	<b>Status</b>
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FLTEN	FRFSH[9:0] = 0x000 (default)		FRFSH[9: 0x001 to 0	
	No Fault	Fault	No Fault	Fault
1	Pulled high externally	Low	Rectangular signal	Low
0	Pulled high externally		Rectangular	signal

The refresh signal frequency (f<sub>REFRESH</sub>) is set by FRFSH[9:0]. If FRFSH[9:0] = 0x000, then RFSH/FLT outputs high. If FRFSH[9:0] = 0x001~0x3FF, then RFSH/FLT outputs a rectangular signal. f<sub>REFRESH</sub> can be calculated with Equation (3):

$$f_{REFRESH} = \frac{127500}{FRFSH} \times \frac{f_{PWM}}{250} \quad (Hz)$$
 (3)

Where FRFSH is the FRFSH[9:0] value (>0), and  $f_{PWM}$  is set by register FPWM[1:0] to 220Hz, 250Hz, 280Hz, or 330Hz.

Note that all values in Equation (3) are decimal-based and f<sub>REFRESH</sub> does not change until the 8MSB are written.

If FRFSH[9:0] is written to 0x000, then the read back value is 0x1A9 to avoid a zero denominator in the internal calculation (see Equation 3).

The internal oscillator is divided by 8. As the clock refreshes the frequency generation, the FRFSH[9:0] register sets the counter number (see Figure 6).

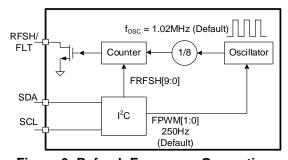


Figure 6: Refresh Frequency Generation

#### **LED Current Slew Rate Control**

To reduce EMI, change the  $I_{LED}$  rising and falling slew rate in PWM dimming. The  $I_{LED}$  rising and falling slew rate is controlled by the SLEW[1:0] register. Table 3 shows the SLEW[1:0] register settings for the different slew rates.

**Table 3: Slew Rate Setting** 

SLEW[1:0]	Slew Rate
00	No slew rate
01	5µs
10	10µs
11	20µs

#### **Protections**

The MPQ3323B employs UVLO protection, LED short protection, LED open protection, and thermal shutdown.

The RFSH/FLT pin is an active-low, open-drain output that is pulled high to an external voltage source. If a fault occurs, the corresponding fault bit is set and RFSH/FLT is pulled low.

For LED open and short protection, hiccup mode or latch-off mode can be selected via the LATCH bit via the I<sup>2</sup>C.

If LATCH = 1, the MPQ3323B initiates latch-off mode once a fault occurs. The fault channel remains off until either VIN or EN turns off and resets. After the fault bit is read, FRSH/FLT is pulled high and the fault bit sets. If the fault bit is read again, then the fault bit resets.

If LATCH = 0, the MPQ3323B enters hiccup mode, during which the fault channel tries to conduct for  $32\mu s$  every 1ms to detect whether the fault has been cleared. Once the fault is removed, FRSH/FLT is pulled high automatically and the fault bit resets when it is read.

#### V<sub>IN</sub> Under-Voltage Lockout (UVLO) Protection

If  $V_{\text{IN}}$  drops to the  $V_{\text{IN}}$  UVLO threshold, then the IC shuts down and the I<sup>2</sup>C registers are reset.

#### **LED Open Protection**

The LEDx (x = 1, 2, 3, or 4) voltage ( $V_{LEDx}$ ) drops when an LED is open. If  $V_{LEDx}$  drops below the protection threshold (about 100mV) for 4ms, then LED open protection is triggered. In this scenario, the fault channel turns off, the corresponding open fault bit (CHxO, where x = 1, 2, 3, or 4) is set, and RFSH/FLT is pulled low.



#### **LED Short Protection**

If an LED short occurs, and  $V_{LEDx}$  (x = 1, 2, 3, or 4) exceeds the voltage set by STH[1:0] for 4ms, then LED short protection is triggered. The short channel turns off, the corresponding fault bit (CHxS, where x = 1, 2, 3, or 4) is set, and RFSH/FLT is pulled low.

The LED short protection threshold ( $V_{SLP}$ ) can be configured via the STH[1:0] register. Table 4 shows the STH[1:0] register setting for different LED short protection thresholds.

**Table 4: LED SCP Threshold Setting** 

STH[1:0]	V <sub>SLP</sub>
00	2V
01	3V
10	4V
11	5V

# **Over Temperature Protection (OTP)**

If the IC temperature exceeds 170°C, then overtemperature protection (OTP) is triggered, all channels turn off, RFSH/FLT is pulled low, and FT\_OTP is set. Once the temperature drops to about 150°C, all channels turn on again and the IC resumes normal operation.



# I<sup>2</sup>C INTERFACE

#### I<sup>2</sup>C Chip Address

The device address is  $0x30\sim0x39$ , which can be configured via the ADDR resistor ( $R_{ADDR}$ ). The internal current source flows to  $R_{ADDR}$ , and the ADDR voltage ( $V_{ADDR}$ ) determines the I<sup>2</sup>C address. Ten different addresses can be configured via  $R_{ADDR}$ .

Table 5 shows the various resistor ratio ( $R_{ADDR}$  /  $R_{ISET}$ ) configurations to set the  $I^2C$  address.

Table 5: I<sup>2</sup>C Address Setting

RADDR, RISET	l <sup>2</sup> C Address (A3, A2, A1, A0)
< 0.05	0000
>0.05, <0.15	0001
>0.15, <0.25	0010
>0.25, <0.35	0011
>0.35, <0.45	0100
>0.45, <0.55	0101
>0.55, <0.65	0110
>0.65, <0.75	0111
>0.75, <0.85	1000
>0.85, <0.95	1001

At start-up, the IC checks the I<sup>2</sup>C address first. This address remains the same during operation until the IC's power is reset.

After a start (S) condition, the  $I^2C$ -compatible master sends a 7-bit address, followed by an eighth data direction bit (where 1 = read and 0 = write). The eighth bit indicates the register address to/from which the data is written/read (see Figure 7).

0 1 1	А3	A2	A1	A0	R/W
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Figure 7: The I<sup>2</sup>C-Compatible Device Address

To avoid glitches during normal operation, follow the steps below:

- 1. Change the FPWM[1:0] value only when the EN bit is set to 0.
- 2. Write the FPWM[1:0] register, then resume writing to the other registers after a 10μs delay.



# I<sup>2</sup>C REGISTER MAP

Name	R/W	Add	Default	D7	D6	D5	D4	D3	D2	D1	D0
ILED_FRE	R/W	00h	01			DEG	I ERVED			ED\//	l M[1:0]
DEV_CON	R/W	01h	91	FLTEN	LATCH		H[1:0]	SLEV	W[1:0]	PS_EN	EN
REFRESH_1	R/W	02h	01	ILILIN		RESERVE		OLL	FT_OTP		H[1:0]
REFRESH_2	R/W	03h	6A			INLOLINAL		SH[9:2]	111_011	11110	11[1.0]
CHN_EN1	R/W	04h	FF		CH4F	EN[3:0]	1111	) 1[0. <u>2</u> ]	CH3E	:N[3·0]	
CHN_EN2	R/W	05h	FF			=N[3:0]			CH1E		
FAU_OP1	R	06h	00		RESERVE		CH4O		RESERVE		CH3O
FAU_OP2	R	07h	00		RESERVE		CH2O		RESERVE		CH10
FAU_SH1	R	08h	00		RESERVE		CH4S		RESERVE		CH3S
FAU_SH2	R	09h	00		RESERVE		CH2S		RESERVE		CH1S
ILED_CH1	R/W	0Ah	3F		RVED	Ī	00		1[5:0]		
DPWM_CH1_1	R/W	0Bh	0F			RVED				1[3:0]	
DPWM_ CH1_2	R/W	0Ch	FF				PWM	1[11:4]			
ILED_CH1	R/W	0Dh	3F	RESE	RVED			ICH	1[5:0]		
DPWM_CH1_1	R/W	0Eh	0F			RVED			PWM	1[3:0]	
DPWM_ CH1_2	R/W	0Fh	FF				PWM	1[11:4]			
ILED_CH1	R/W	10h	3F	RESE	RVED			ICH	1[5:0]		
DPWM_CH1_1	R/W	11h	0F		RESE	RVED			PWM	1[3:0]	
DPWM_CH1_2	R/W	12h	FF				PWM	1[11:4]			
ILED_CH1	R/W	13h	3F	RESE	RVED			ICH	1[5:0]		
DPWM_CH1_1	R/W	14h	0F		RESE	RVED			PWM	1[3:0]	
DPWM_CH1_2	R/W	15h	FF				PWM	1[11:4]			
ILED_CH2	R/W	16h	3F	RESE	RVED			ICH:	2[5:0]		
DPWM_CH2_1	R/W	17h	0F		RESE	RVED			PWM	2[3:0]	
DPWM_CH2_2	R/W	18h	FF				PWM	2[11:4]			
ILED_CH2	R/W	19h	3F	RESE	RVED			ICH:	2[5:0]		
DPWM_CH2_1	R/W	1Ah	0F		RESE	ERVED		PWM2[3:0]			
DPWM_CH2_2	R/W	1Bh	FF			1	PWM	2[11:4]			
ILED_CH2	R/W	1Ch	3F	RESE	RVED			ICH:	2[5:0]		
DPWM_CH2_1	R/W	1Dh	0F		RESE	RVED			PWM	2[3:0]	
DPWM_CH2_2	R/W	1Eh	FF			1	PWM	2[11:4]			
ILED_CH2	R/W	1Fh	3F	RESI	RVED			ICH	2[5:0]		
DPWM_CH2_1	R/W	20h	0F		RESI	ERVED	D) 4 (8 4	0544.43	PWM	12[3:0]	
DPWM_CH2_2	R/W	21h	FF	DEOL	-D\/ED	1	PWM	2[11:4]	10[5 0]		
ILED_CH3	R/W	22h	3F	RESI	RVED			ICH	3[5:0]	1010-01	
DPWM_CH3_1 DPWM_CH3_2	R/W	23h	0F FF		KE5I	ERVED	D\A/NA	<u> </u> 3[11:4]	PVVIV	13[3:0]	
	R/W	24h	3F	DECI	DVED.	1	PVVIVI		12[E+0]		
ILED_CH3 DPWM_CH3_1	R/W R/W	25h 26h	0F	KESI	RVED	L ERVED		ICH	[3[5:0]	13[3:0]	
DPWM_CH3_2	R/W	27h	FF		KESI	LKVED	D\\/N/	<u> </u> 3[11:4]	F VVIV	i3[3.0]	
ILED_CH3	R/W	28h	3F	DEG	ERVED		L AAIAI		3[5:0]		
DPWM_CH3_1	R/W	29h	0F	INLO		ERVED		1011		13[3:0]	
DPWM_CH3_2	R/W	2Ah	FF		INLOI	LIVLD	D\\/M	] 3[11:4]	1 0010	13[3.0]	
ILED_CH3	R/W	2Bh	3F	RESI	RVED		1 77171		3[5:0]		
DPWM_CH3_1	R/W	2Ch	0F	INLO		RESERVE	:D	1011		PWM3[3:0	1
DPWM_CH3_2	R/W	2Dh	FF			TALOLIA VE		3[11:4]	I	1 11110[0.0	1
ILED_CH4	R/W	2Eh	3F	PWM3[11:4]  RESERVED   ICH4[5:0]							
DPWM_CH4_1	R/W	2Fh	0F	RESERVED   ICH4[5:0]   PWM4[3:0]				1			
DPWM_CH4_2	R/W	30h	FF					4[11:4]			4
ILED_CH4	R/W	31h	3F	RESE	RVED				4[5:0]		
DPWM_CH4_1	R/W	32h	0F			RESERVE	:D			PWM4[3:0	1
DPWM_CH4_2	R/W	33h	FF					4[11:4]	1		
ILED_CH4	R/W	34h	3F	RESI	ERVED				4[5:0]		
DPWM_CH4_1	R/W	35h	0F			RESERVE	:D			PWM4[3:0	1



# I<sup>2</sup>C REGISTER MAP (continued)

Name	R/W	Add	Default	D7	D6	D5	D4	D3	D2	D1	D0
DPWM_CH4_2	R/W	36h	FF	PWM4[11:4]							
ILED_CH4	R/W	37h	3F	RESE	RVED			ICH <sup>2</sup>	<del>1</del> [5:0]		
DPWM_CH4_1	R/W	38h	0F			RESERVE	D			PWM4[3:0]	
DPWM_CH4_2	R/W	39h	FF				PWM	4[11:4]			



# I<sup>2</sup>C REGISTER DESCRIPTION

# ILED\_FRE (00h)

The ILED\_FRE command sets the LED current (I<sub>LED</sub>) frequency.

Bits	Name	Access	Default	Description
7:2	RESERVED	R	N/A	Reserved.
1:0	FPWM[1:0]	R/W	2'b 01	Sets the pulse-width modulation (PWM) dimming frequency.  00: 220Hz 01: 250Hz 10: 280Hz 11: 330Hz To avoid glitches during operation, follow the steps below:  • Change the FPWM[1:0] value only when the EN bit is set to 0.  • Write the FPWM[1:0] register, then resume writing to the other registers after a 10µs delay.

# DEV\_CON (01h)

The DEV\_CON command controls the device.

Bits	Name	Access	Default	Description
				Enables the RFSH/FLT fault indicator.
7	FLTEN	R/W	1'b1	0: Disabled. RFSH/FLT refreshes the signal output 1: Enabled. RFSH/FLT indicates if a fault has occurred
				Enables latch-off mode.
6	LATCH	R/W	1'b0	0: Disabled. Hiccup mode enabled if a fault occurs 1: Enabled. Latch-off mode enabled if a fault occurs
				Sets the LED short protection threshold (V <sub>SLP</sub> ).
5:4	STH[1:0]	R/W	2'b 01	00: 2V 01: 3V 10: 4V 11: 5V
				Sets the LED current (I <sub>LED</sub> ) slew rate.
3:2	SLEW[1:0]	R/W	2'b 00	00: No slew rate 01: 5μs 10:10μs 11: 20μs
				Enables the phase shift.
1	PS_EN	R/W	1'b0	0: Disabled 1: Enabled. The rising edge of channel x + 1 (where x = 1, 2, or 3) ILED occurs 160µs after the rising edge of channel x's ILED
				Enables the IC.
0	EN	R/W	1'b1	0: Disabled 1: Enabled



# REFRESH\_1 (02h)

The REFRESH\_1 command sets the RFSH/FLT refresh frequency (f<sub>REFRESH</sub>) (2LSB).

Bits	Name	Access	Default	Description
7:3	RESERVED	R	-	Reserved.
2	FT_OTP	R	1'b0	Indicates whether an over-temperature (OT) fault has occurred.  0: An OT fault has not occurred
				1: An OT fault has occurred
				Sets the 2 least significant bits (LSB) of f <sub>REFRESH</sub> .  FRFSH[9:0] = 0x000, outputs a high voltage FRFSH[9:0] > 0, f <sub>REFRESH</sub> can be calculated with the following equation:
1:0	1:0 FRFSH[1:0] R/W	2'b 01	$f_{REFRESH} = \frac{127500}{FRFSH} \times \frac{f_{PWM}}{250} (Hz)$	
				Note that all of the numbers in the equation have a decimal base. $f_{REFRESH}$ does not change until the 8MSB is written. The default FRFSH[1:0] = 00, but read back is 01.

# REFRESH\_2 (03h)

The REFRESH\_2 command sets the RFSH/FLT f<sub>REFRESH</sub> (8MSB).

Bits	Name	Access	Default	Description
				Sets the 8MSB of f <sub>REFRESH</sub> .
				FRFSH[9:0] = 0x000, outputs a high voltage FRFSH[9:0] > 0, frefresh can be calculated with the following equation:
7:3	FRFSH[9:2]	R/W	8'b 01101010	$f_{REFRESH} = \frac{127500}{FRFSH} \times \frac{f_{PWM}}{250} (Hz)$
				Note that all of the numbers in the equation have a decimal base. frefresh does not change until the 8MSB is written. The default FRFSH[9:2] = 0x00, but read back is 6A.

# CHN\_EN1 (04h)

The CHN\_EN1 command sets the channel 3~4 enable bits.

Bits	Name	Access	Default	Description
7:4	CH4EN	R/W	4'b1111	Enables channel 4. 0000: Disabled 1111: Enabled
3:0	CH3EN	R/W	4'b1111	Enables channel 3. 0000: Disabled 1111: Enabled



# CHN\_EN2 (05h)

The CHN\_EN2 command sets the channel 1~2 enable bits.

Bits	Name	Access	Default	Description
7.4	OLIOEN DAW	DAM	R/W 4'b1111	Enables channel 2.
7:4	CH2EN	R/VV	401111	0000: Disabled 1111: Enabled
				Enables channel 1.
3:0	CH1EN	R/W	4'b1111	0000: Disabled 1111: Enabled

# **FAU\_OP1 (06h)**

The FAU\_OP1 command reads the channel 3~4 open fault bits.

Bits	Name	Access	Default	Description
7:5	RESERVED	R	-	Reserved.
			(	Channel 4 open protection fault flag.
4	CH4O	R	1'b0	0: No fault 1: Fault
3:1	RESERVED	R	-	Reserved.
				Channel 3 open protection fault flag.
0	CH3O	R	1'b0	0: No fault 1: Fault

# **FAU\_OP2 (07h)**

The FAU\_OP2 command reads the channel 1~2 open fault bits.

Bits	Name	Access	Default	Description
7:5	RESERVED	R	1	Reserved.
				Channel 2 open protection fault flag.
4	CH2O	R	1'b0	0: No fault 1: Fault
3:1	RESERVED	R	-	Reserved.
				Channel 1 open protection fault flag.
0	CH1O	R	1'b0	0: No fault 1: Fault

# FAU\_SH1 (08h)

The FAU\_SH1 command reads the channel 3~4 short fault bits.

Bits	Name	Access	Default	Description
7:5	RESERVED	R	-	Reserved.
4	CH4S	R	1'b0	Channel 4 short protection fault flag.  0: No fault 1: Fault
3:1	RESERVED	R	-	Reserved.



	0	CH3S	R	4150	Channel 3 short protection fault flag.  0: No fault 1: Fault
--	---	------	---	------	--

# FAU\_SH2 (09h)

The FAU\_SH2 command reads the channel 1~2 short fault bits.

Bits	Name	Access	Default	Description
7:5	RESERVED	R	-	Reserved.
4	CH2S	R	1'b0	Channel 2 short protection fault flag.  0: No fault 1: Fault
3:1	RESERVED	R	-	Reserved.
0	CH1S	R	1'b0	Channel 1 short protection fault flag.  0: No fault 1: Fault

# ILED\_CH1 (0Ah, 0Dh, 10h, and 13h)

The ILED CH1 command sets the channel 1 ILED.

Bits	Name	Access	Default	Description
7:6	RESERVED	R	-	Reserved.
5:0	ICH1[5:0]	R/W	6'b 111111	Sets the channel 1 $I_{LED}$ for analog dimming, which can be calculated with the following equation: $I_{LED} = \frac{Code}{63} \times I_{SET}$

# DPWM\_CH1\_1 (0Bh, 0Eh, 11h, and 14h)

The DPWM\_CH1\_1 command sets the 4LSB for the channel 1 ILED PWM dimming duty (DPWM).

	Bits	Name	Access	Default	Description
Ī	7:4	RESERVED	R	-	Reserved.
	3:0	PWM1[3:0]	R/W	4'b 1111	Sets the 4LSB for the channel 1 $I_{\text{LED}}$ $D_{\text{PWM}}$ . $D_{\text{PWM}}$ only changes when the 8MSB are written.

# DPWM\_CH1\_2 (0Ch, 0Fh, 12h, and 15h)

The DPWM\_CH1\_2 command sets the 8MSB for the channel 1 I<sub>LED</sub> D<sub>PWM</sub>.

Bits	Name	Access	Default	Description
7:0	PWM1[11:4]	R/W		Sets the 8MSB for the channel 1 $I_{\text{LED}}$ $D_{\text{PWM}}.$ $D_{\text{PWM}}$ only changes when the 8MSB are written.

# ILED\_CH2 (16h, 19h, 1Ch, and 1Fh)

The ILED\_CH2 command sets the channel 2 ILED.

Bits	Name	Access	Default	Description
7:6	RESERVED	R	-	Reserved.
5:0	ICH2[5:0]	R/W	6'b 111111	Sets the channel 2 I <sub>LED</sub> for analog dimming, which can be calculated with the following equation: $I_{LED} = \frac{Code}{63} \times I_{SET}$



# DPWM\_CH2\_1 (17h, 1Ah, 1Dh, and 20h)

The DPWM\_CH2\_1 command sets the 4LSB for the channel 2 I<sub>LED</sub> D<sub>PWM</sub>.

Bits	Name	Access	Default	Description
7:4	RESERVED	R	-	Reserved.
3:0	PWM2[3:0]	R/W	4'b 1111	Sets the 4LSB for the channel 2 $I_{\text{LED}}$ $D_{\text{PWM}}.$ $D_{\text{PWM}}$ only changes when the 8MSB are written.

# DPWM\_CH2\_2 (18h, 1Bh, 1Eh, and 21h)

The DPWM\_CH2\_2 command sets the 8MSB for the channel 2 I<sub>LED</sub> D<sub>PWM</sub>.

Bits	Name	Access	Default	Description
7:0	PWM2[11:4]	R/W		Sets the 8MSB for the channel 2 $I_{\text{LED}}$ $D_{\text{PWM}}.$ $D_{\text{PWM}}$ only changes when the 8MSB are written.

#### ILED\_CH3 (22h, 25h, 28h, and 2Bh)

The ILED CH3 command sets the channel 3 ILED.

	Bits	Name	Access	Default	Description
	7:6	RESERVED	R	-	Reserved.
=	5:0	ICH3[5:0]	R/W	6'b 111111	Sets the channel 3 $I_{LED}$ for analog dimming, which can be calculated with the following equation: $I_{LED} = \frac{Code}{63} \times I_{SET}$

# DPWM\_CH3\_1 (23h, 26h, 29h, and 2Ch)

The DPWM\_CH3\_1 command sets the 4LSB for the channel 3 I<sub>LED</sub> D<sub>PWM</sub>.

Bits	Name	Access	Default	Description
7:4	RESERVED	R	-	Reserved.
3:0	PWM3[3:0]	R/W	4'b 1111	Sets the 4LSB for the channel 3 $I_{\text{LED}}$ $D_{\text{PWM}}$ . $D_{\text{PWM}}$ only changes when the 8MSB are written.

#### DPWM CH3 2 (24h, 27h, 2Ah, and 2Dh)

The DPWM\_CH3\_2 command sets the 8MSB for the channel 3 I<sub>LED</sub> D<sub>PWM</sub>.

Bits	Name	Access	Default	Description
7:0	PWM3[11:4]	R/W		Sets the 8MSB for the channel 3 I <sub>LED</sub> D <sub>PWM</sub> . D <sub>PWM</sub> only changes when the 8MSB are written.

# ILED\_CH4 (2Eh, 31h, 34h, and 37h)

The ILED\_CH4 command sets channel 4 ILED.

Bits	Name	Access	Default	Description			
7:6	RESERVED	R	-	Reserved.			
5:0	ICH4[5:0]	R/W	6'b 111111	Sets the channel 4 $I_{LED}$ for analog dimming, which can be calculated with the following equation: $I_{LED} = \frac{Code}{63} \times I_{SET}$			



# DPWM\_CH4\_1 (2Fh, 32h, 35h, and 38h)

The DPWM\_CH4\_1 command sets the 4LSB for the channel 4 I<sub>LED</sub> D<sub>PWM</sub>.

Bits	Name	Access	Default	Description
7:4	RESERVED	R	-	Reserved.
3:0	PWM4[3:0]	R/W	4'b 1111	Sets the 4LSB for the channel 4 $I_{\text{LED}}$ $D_{\text{PWM}}.$ $D_{\text{PWM}}$ only changes when the 8MSB are written.

# DPWM\_CH4\_2 (30h, 33h, 36h, 39h)

The DPWM\_CH4\_2 command sets the 8MSB for the channel 4  $I_{\text{LED}}$   $D_{\text{PWM}}$ .

Bits	Name	Access	Default	Description
7:0	PWM4[11:4]	R/W		Sets the 8MSB for the channel 4 $I_{\text{LED}}$ $D_{\text{PWM}}.$ $D_{\text{PWM}}$ only changes when the 8MSB are written.



# APPLICATION INFORMATION

# **Setting the LED Current**

Connect a resistor from the ISET pin to GND to set  $I_{LED}$  for all four channels.  $I_{LED}$  can be calculated with Equation (4):

$$I_{LED}(mA) = \frac{4800}{R_{ISET}(k\Omega)}$$
(4)

# **PCB Layout Guidelines**

Efficient PCB layout is critical for stable operation. For the best results, refer to Figure 8 and following the guidelines below:

- 1) Place the VIN capacitor close to the VIN pin.
- 2) Add multiple vias to the capacitor's GND.
- Ensure that the traces from the LED anode to the LEDx pins are wide enough to support the set current (up to 320mA).

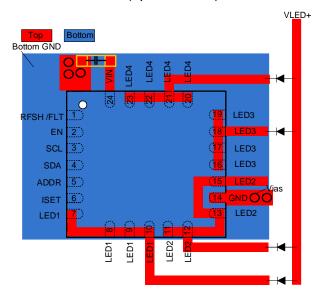


Figure 8: Recommended PCB Layout



# TYPICAL APPLICATION CIRCUITS

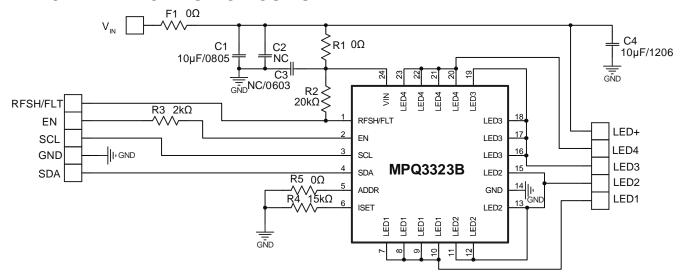


Figure 9: Typical Application Circuit (ILED = 320mA/Channel)

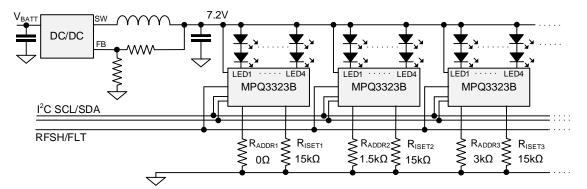
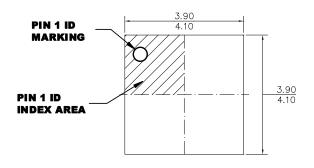


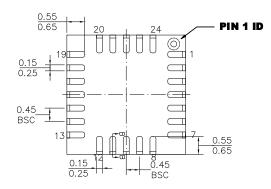
Figure 10: Typical System Application Circuit (2 LED in Series, ILED = 320mA/Channel)



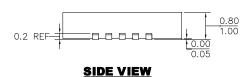
# **PACKAGE INFORMATION**

# QFN-24 (4mmx4mm) Wettable Flank

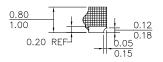




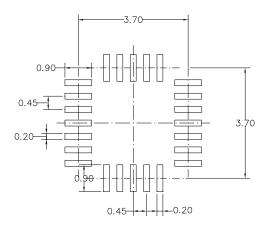
#### **TOP VIEW**



#### **BOTTOM VIEW**



**SECTION B-B** 



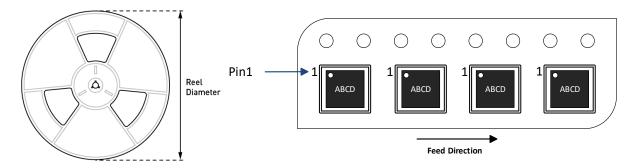
# NOTE:

- 1) THE LEAD SIDE IS WETTABLE.
- 2) ALL DIMENSIONS ARE IN MILLIMETERS.
- 3) LEAD COPLANARITY SHALL BE 0.08 MILLIMETERS MAX.
- 4) JEDEC REFERENCE IS MO-220.
- 5) DRAWING IS NOT TO SCALE.

**RECOMMENDED LAND PATTERN** 



# **CARRIER INFORMATION**



Part Number	Package Description	Quantity/ Reel	Quantity/ Tube	Quantity/ Tray	Reel Diameter	Carrier Tape Width	Carrier Tape Pitch
MPQ3323BGRE- AEC1-Z	QFN-24 (4mmx4mm)	5000	N/A	N/A	13in	12mm	8mm



# **REVISION HISTORY**

Revision #	Revision Date	Description	Pages Updated	
1.0	4/13/2023	Initial Release	-	

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